IPC  ASSOCIATION CONNICELECTRONICS INDUS	© Copyright 2005. I	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					ials and Mfg Information			
upplier Info	formation													
Company name*			Company unique ID			J	Unique ID Authority				Response Date*			
nsemi											2024-05-09			
Contact Name		Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env-St	Stewards		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
uthorized Rep	presentative*	Title - Representative			I	Phone - Representative*			Email - Representative*					
Product-Env-St	Stewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
Requ	Requester Item Number Mfr		Item Number Mfr Item Name				Effective Date	Version	N	Manufacturing Site	V	Veight*	UOM	Unit Type
		NCL30186DDR2G LED lighting cor		LED lighting contro	oller		2024-05-09 PH1		PH1	7	1.76	mg	Each	
Ianufacturi	ing Proccess Informa	ntion												
Terminal Plating / Grid Array Material Terminal Base Alloy			Alloy J-S	STD-020 MSL	D-020 MSL Rating Peak Process Body Temperature Max Time at				e Max Time at Peak	Temperatu	re Numb	er of Reflow Cyc	eles	
Matte Tin (Sn) - annealed C			CU Alloy 1				260   C   30			seconds 3				
omments														
vel 1 - maximu	um time at peak temperat	ure during sol	dering is 10-3	30 seconds										
or more inform	mation regarding material	composition	please refer t	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have not independently verified and or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.03	mg	Supplier	Silicon (Si)	7440-21-3		1.03	mg
Die Attach	0.09	mg	Supplier	Organic peroxide	3006-86-8		0.0007	mg
			Supplier	Diluent B	Proprietary Data		0.0045	mg
			Supplier	Diluent A	Proprietary Data		0.0036	mg
			Supplier	Dicyandiamine	461-58-5		0.0002	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.072	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.009	mg
Lead Frame	37.62	mg	Supplier	Silver (Ag)	7440-22-4		0.2257	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0451	mg
			Supplier	Iron (Fe)	7439-89-6		0.8841	mg
			Supplier	Copper (Cu)	7440-50-8		36.4538	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0113	mg
Mold Compound-Black	31.03	mg		Epoxy resin	proprietary data		1.5515	mg
			Supplier	Phenolic Resin	Proprietary Data		0.6206	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.7758	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1551	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		27.927	mg
Plating	1.89	mg	Supplier	Tin (Sn)	7440-31-5		1.89	mg
Wire Bond	0.1	mg	Supplier	Palladium (Pd)	7440-05-3		0.0021	mg
			Supplier	Gold (Au)	7440-57-5		0.0003	mg
			Supplier	Copper (Cu)	7440-50-8		0.0976	mg